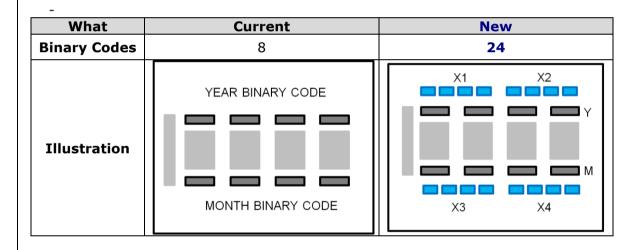
PCN Nu	mber:	20211223000.0				PC	N Date:	January 04, 2022
Title:	SOT Symboli	update fo	r select	devices - 16 Ad	ditio	nal Binary	Codes	
Customer Contact:		PCN Manager		Dept:	Quality Services			
Change	Type:							
Ass	Assembly Site		Assembly Process			Assembly Materials		
Design			Datasheet			Mechanical Specification		
Test Site			Packing/Shipping/Labeling				Test Prod	cess
Wafer Bump Site			Wafer Bump Material			Wafer Bump Process		
Wafer Fab Site			Wafer I	Wafer Fab Materials			Wafer Fab Process	
			Part number change					

PCN Details

Description of Change:

This letter is to inform customers of a device symbolization change for select devices in the SOT package that will enable enhanced device level traceability. The symbolization will maintain current Year/Month binary codes and add 4 additional binary codes (i.e. X1, X2, X3, and X4) for enhanced lot traceability as follows:



Reason for Change:

Improved Device traceability

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

None

Changes to product identification resulting from this PCN:

Added device symbolization row

Product Affected:

LM2903BIDDFR	OPA2990IDDFR	TLV7032DDFR	TLV9102IDDFR
LM393BIDDFR	OPA2990TIDDFR	TLV7032DDFT	TLV9152IDDFR
LM74500QDDFRQ1	OPA2991IDDFR	TLV7042DDFR	TLV9302IDDFR
LM74700MDDFREP	TLV6742IDDFR	TLV7042DDFT	TLV9352IDDFR
LM74700QDDFRQ1	TLV7012DDFR	TLV9042IDDFR	V62/21608
OPA2375IDDFR	TLV7022DDFR	LM74500QDDFRQ1	LM74700QDDFRQ1

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail		
USA	PCNAmericasContact@list.ti.com		
Europe	PCNEuropeContact@list.ti.com		
Asia Pacific	PCNAsiaContact@list.ti.com		
WW PCN Team	PCN ww admin_team@list.ti.com		

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